



Case Docket No. 91-627 120628 A

The Commissioner of Patents and Trademarks
Washington, D.C. 20231

Transmitted herewith for filing is the the patent application of:
Inventor: Warren M. Farnsworth, Alan G. Wood, Trung T. Doan, David R. Hembree

For: BONDPAD ATTACHMENTS HAVING SELF-LIMITING PROPERTIES FOR PENETRATION OF
Prior Application: SEMICONDUCTOR DIE. (as amended)

Examiner: unassigned Art Unit: unassigned

This is a Request for Filing a:

Continuation Divisional

application under 37 CFR 1.60, of pending prior application
serial no. 08/073,003 filed on (date) 6/7/93

of (inventors) Warren M. Farnsworth et al.

for (invention title) BONDPAD ATTACHMENTS USED TO TEMPORARILY CONNECT SEMICONDUCTOR DIE.

Enclosed are:

- Original specification (_____ pages including Abstract)
- Executed Declaration
- _____ sheets of drawings
- An assignment of the invention to _____
- Information Disclosure Statement including copies

1) Copy of Prior Application as Filed Which is Attached:

I hereby verify that the attached papers are a true copy of what is shown in my records to be the above identified prior application, including the oath or declaration originally filed (37 CFR 1.60)

The copy of the papers of prior application as filed which are attached are as follows:

- 25 page(s) of specifications
- 25 page(s) of claims
- 1 page(s) of abstract
- 9 page(s) of drawings
(also complete part 4 below if drawings are to be transferred)

3 page(s) of declaration and power of attorney

If the copy of the declaration being filed does not show applicant's signature, indicate on the declaration that it was signed and complete the following:

in accordance with the indication required by 37 CFR 60(b) my records reflect that the original signed declaration showing applicant's signature was filed on _____.

2) Amendments:

- Cancel in this application original claims _____ of the prior application before calculating the filing fee. (At least one original independent claim must be retained for filing purposes.)
- A preliminary amendment is enclosed.

3) Relate-Back - 35 U 120:

4) Drawings:

Do not check the following box if prior case is not to be abandoned.

- Transfer the drawings from the prior application to this application and, subject to item 17 below, abandon said prior application as of the the filing date accorded this application. A duplicate copy of this request is enclosed for filing in the prior application file. (May only be used if signed by (1) applicant, (2) assignee of record or (3) attorney or agent of record authorized by 37 CFR 1.138 and before payment of issue fee.)
- Transfer the following sheet(s) of drawings from the prior application to this application.

New drawings are enclosed

5) Assignment:

The prior application is assigned of record to:

APPLICANT: Micron Technology, Inc.

ADDRESS: 2805 E. Columbia Road
Boise, Idaho 83706

Assignment recorded in PTO on June 7, 1993
Reel 6582 Frame 044

6) Fee Calculation:

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)*
For:	No. Filed	No. Extra
Basic Fee:		
Total Claims:	27 - 20 =	* 7
Indep Claims:	4 - 3 =	* 1

Multiple Dependent Claims Presented
 * If the difference in Col. 1 is less
 than zero, enter '0' in Col. 2

Rate	Fee
$\frac{1}{2}$ x 22 =	\$ 710
$\frac{1}{2}$ x 74 =	\$ 154
$\frac{1}{2}$ + 230 =	\$ 74
$\frac{1}{2}$ + 230 =	\$ 0
Total:	\$ 938

Assignment Recording Fee, if applicable \$ 40

7) Payment of Fees:

Please charge my Deposit Account No. 13-3092 in the amount of \$ 938.
A duplicate copy of this sheet is enclosed.

A check in the amount of \$ _____ to cover the filing fee and assignment recording fee (if applicable) is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 13-3092.
A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 CFR 1.16.

Any patent application processing fees under 37 CFR 1.17.

The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 13-3092.
A duplicate copy of this sheet is enclosed.

Any patent application processing fees under 37 CFR 1.17.

The issue fee set in 37 CFR 1.18 at or before mailing of the Notice of Allowance, pursuant to 37 CFR 1.311(b).

Any filing fees under 37 CFR 1.16 for presentation of extra claims.

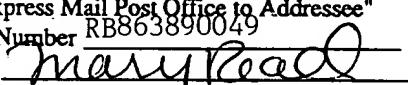
8) Maintenance of Copendency of Prior Application:

Applicant petitions to extend the term in the pending prior application until this application is filed. Please charge any fees to deposit account No. 13-3092.
A *triplicate* copy of this sheet is enclosed.

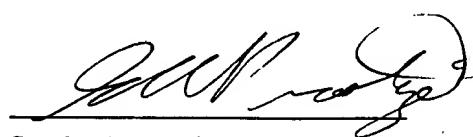
9) Abandonment of Prior Application (if applicable):

Please abandon the prior application at a time while the prior application is pending or when the petition for extension of time or to revive in that application is granted a filing date so as to make this application copending with said prior application.

I hereby declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.


I hereby certify that this paper and the documents referred to as enclosed therein are being deposited with the United States Postal Service on this date 9/13/93 in an envelope as "Express Mail Post Office to Addressee"
Mailing Label Number RB863890049

(Signature of person mailing papers)


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